

150mA 10V INPUT LDO REGULATOR

NO.EA-245-160324

OUTLINE

The RP171x Series are CMOS-based LDO regulators featuring 150mA output current. Because of the 10V maximum input voltage, RP171x can be used in 2 cell lithium-ion battery powered portable appliances and besides a portable equipment. The supply current is Typ. 23 μ A though an excellent response characteristics.

The output voltage range from 1.2V is possible. The output voltage accuracy and temperature-drift coefficient of output voltage of the RP171x Series are excellent.

RP171x has a fold-back protection circuit and a thermal shutdown circuit. Moreover, a standby mode with ultra low supply current can be realized with the chip enable function.

SC-88A and SOT-23-5 with high power dissipation packages are available.

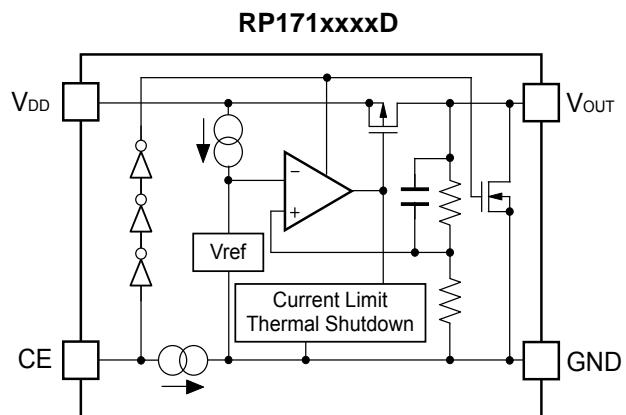
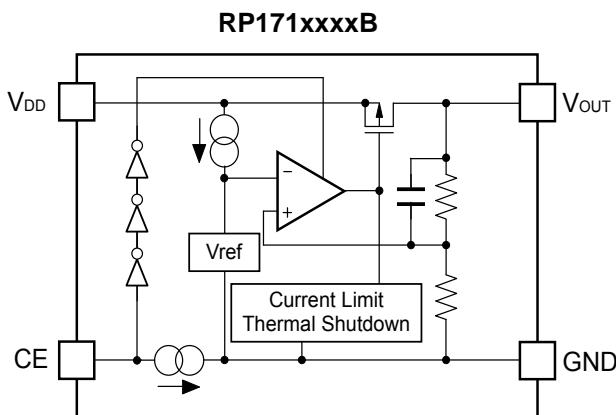
FEATURES

- Supply Current Typ. 23 μ A
- Standby Mode Typ. 0.1 μ A
- Dropout Voltage..... Typ. 0.20V ($I_{OUT}=100mA$, $V_{OUT}=3.0V$)
Typ. 0.40V ($I_{OUT}=150mA$, $V_{OUT}=2.8V$)
- Ripple Rejection Typ. 70dB ($f=1kHz$)
- Temperature-Drift Coefficient of Output Voltage Typ. $\pm 80ppm/\text{ }^{\circ}\text{C}$
- Line Regulation Typ. 0.02%/V
- Output Voltage Accuracy $\pm 1.0\%$
- Packages..... SC-88A, SOT-23-5
- Input Voltage Range..... 2.6V to 10.0V
- Output Voltage Range..... 1.2V to 6.0V (0.1V steps)
(For other voltages, please refer to MARK INFORMATIONS.)
- Built-in Fold Back Protection Circuit..... Typ. 40mA (Current at short mode)
- Built-in Thermal Shutdown Circuit..... Shutdown Temperature at 165 $\text{ }^{\circ}\text{C}$
- Built-in Constant Slope Circuit (Soft-start Function)
- Ceramic capacitors are recommended to be used with this IC 1.0 μ F or more

APPLICATIONS

- Power source for portable communication equipment.
- Power source for electrical appliances such as cameras, VCRs and camcorders.
- Power source for battery-powered equipment.
- Power source for home appliances.

BLOCK DIAGRAMS



SELECTION GUIDE

The output voltage, auto discharge function, and package, etc. for the ICs can be selected at the user's request.

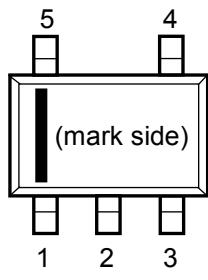
Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
RP171Qxx2*-TR-FE	SC-88A	3,000 pcs	Yes	Yes
RP171Nxx1*-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes

xx: The output voltage can be designated in the range from 1.2V(12) to 6.0V(60) in 0.1V steps.
(For other voltages, please refer to MARK INFORMATIONS.)

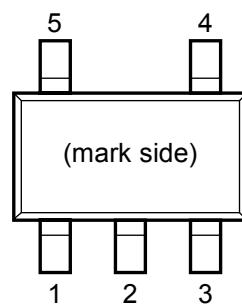
* : The auto discharge function at off state are options as follows.
(B) without auto discharge function at off state
(D) with auto discharge function at off state

PIN CONFIGURATIONS

- SC-88A



- SOT-23-5



PIN DESCRIPTIONS

- SC-88A

Pin No	Symbol	Pin Description
1	CE	Chip Enable Pin ("H" Active)
2	NC	No Connection
3	GND	Ground Pin
4	V _{OUT}	Output Pin
5	V _{DD}	Input Pin

- SOT-23-5

Pin No	Symbol	Pin Description
1	V _{DD}	Input Pin
2	GND	Ground Pin
3	CE	Chip Enable Pin ("H" Active)
4	NC	No Connection
5	V _{OUT}	Output Pin

ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	12	V
V_{CE}	Input Voltage (CE Pin)	12	V
V_{OUT}	Output Voltage	-0.3 to $V_{IN}+0.3$	V
I_{OUT}	Output Current	330	mA
P_D	Power Dissipation* (SC-88A)	380	mW
	Power Dissipation* (SOT-23-5)	420	
T_{opt}	Operating Temperature Range	-40 to 85	°C
T_{stg}	Storage Temperature Range	-55 to 125	°C

*) For Power Dissipation, please refer to PACKAGE INFORMATION.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field.

The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

ELECTRICAL CHARACTERISTICS

V_{IN} =Set $V_{OUT}+1V$, $I_{OUT}=1mA$, unless otherwise noted.

The specifications in are guaranteed by Design Engineering at $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$.

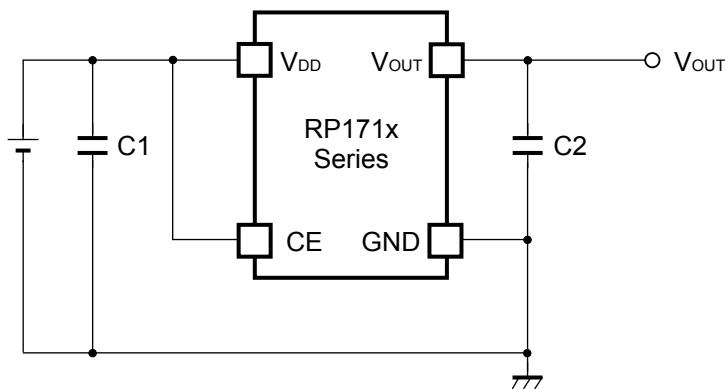
RP171xxxxB/D

 $T_{opt}=25^{\circ}\text{C}$

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
V_{OUT}	Output Voltage	$T_{opt}=25^{\circ}\text{C}$	$V_{OUT} > 1.5\text{V}$	x0.99		x1.01 V
			$V_{OUT} \leq 1.5\text{V}$	-15		+15 mV
	-40°C ≤ T_{opt} ≤ 85°C	$V_{OUT} > 1.5\text{V}$	x0.974		x1.023	V
		$V_{OUT} \leq 1.5\text{V}$	-40		+35	mV
I_{OUT}	Output Current		150			mA
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	0.1mA ≤ I_{OUT} ≤ 150mA		5	40	mV
V_{DIF}	Dropout Voltage	$I_{OUT}=150\text{mA}$	1.2V ≤ $V_{OUT} < 1.3\text{V}$		-	1.400 V
			1.3V ≤ $V_{OUT} < 1.5\text{V}$		-	1.300
			1.5V ≤ $V_{OUT} < 1.8\text{V}$		-	1.100
			1.8V ≤ $V_{OUT} < 2.3\text{V}$		-	0.800
			2.3V ≤ $V_{OUT} < 3.0\text{V}$	0.400	0.580	
			3.0V ≤ $V_{OUT} < 4.0\text{V}$	0.300	0.480	
			4.0V ≤ $V_{OUT} \leq 6.0\text{V}$	0.250	0.400	
I_{SS}	Supply Current	$I_{OUT}=0\text{mA}$		23	40	μA
$I_{standby}$	Standby Current	$V_{IN}=10.0\text{V}$, $V_{CE}=\text{GND}$		0.1	1.0	μA
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	Set $V_{OUT}+0.5\text{V} \leq V_{IN} \leq 10.0\text{V}$ (In case that $V_{OUT} \leq 2.1\text{V}$, $2.6\text{V} \leq V_{IN} \leq 10.0\text{V}$)		±0.02	±0.2	%/V
RR	Ripple Rejection	$f=1\text{kHz}$, Ripple 0.2Vp-p, $I_{OUT}=30\text{mA}$ (In case that $V_{OUT} < 2.0\text{V}$, $V_{IN}=3.0\text{V}$)		70		dB
V_{IN}	Input Voltage		2.6		10	V
$\Delta V_{OUT}/\Delta T_{opt}$	Output Voltage Temperature Coefficient	-40°C ≤ $T_{opt} \leq 85^{\circ}\text{C}$		±80		ppm/°C
I_{SC}	Short Current Limit	$V_{OUT}=0\text{V}$		40		mA
I_{PD}	CE Pull-down Current			0.30		μA
V_{CEH}	CE Input Voltage "H"		1.7			V
V_{CEL}	CE Input Voltage "L"				0.8	V
T_{TSD}	Thermal Shutdown Temperature	Junction Temperature		165		°C
T_{TSR}	Thermal Shutdown Released Temperature	Junction Temperature		110		°C
en	Output Noise	BW=10Hz to 100kHz		100		μVrms
R_{LOW}	Low Output Nch Tr. ON Resistance (of D version)	$V_{IN}=7.0\text{V}$ $V_{CE}=0\text{V}$		250		Ω

All of unit are tested and specified under load conditions such that $T_j \approx T_{opt}=25^{\circ}\text{C}$ except for Output Noise, Ripple Rejection, Output Voltage Temperature Coefficient and Thermal Shutdown.

TYPICAL APPLICATION



(External Components)

C2 1.0 μ F MURATA: GRM155B31A105KE15

TECHNICAL NOTES

When using these ICs, consider the following points:

Phase Compensation

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, use a capacitor C2 with 1.0 μ F or more and good ESR (Equivalent Series Resistance).

(Note: If additional ceramic capacitors are connected with parallel to the output pin with an output capacitor for phase compensation, the operation might be unstable. Because of this, test these ICs with as same external components as ones to be used on the PCB.)

PCB Layout

Make V_{DD} and GND lines sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect a capacitor C1 with a capacitance value as much as 1.0 μ F or more between V_{DD} and GND pin, and as close as possible to the pins.

Set external components, especially the output capacitor C2, as close as possible to the ICs, and make wiring as short as possible.

PACKAGE INFORMATION

• Power Dissipation (SC-88A)

Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:

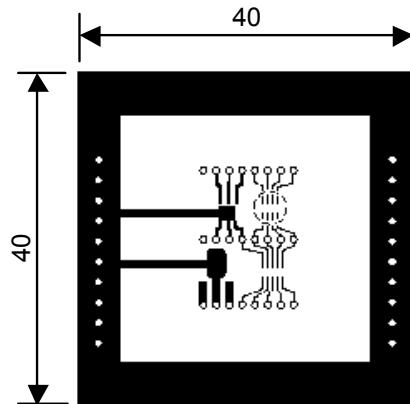
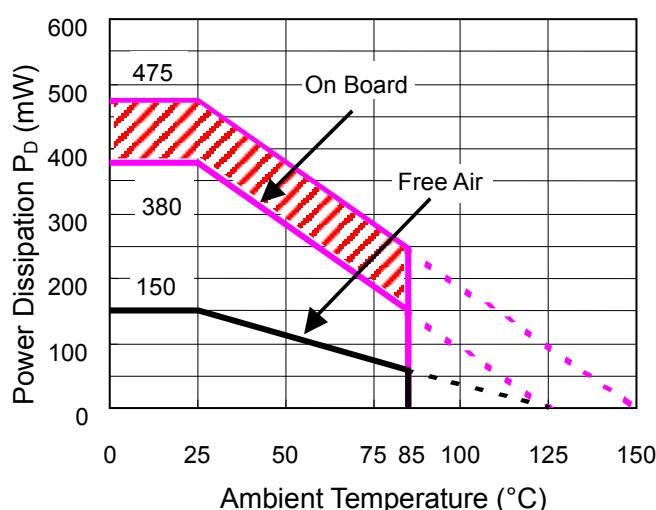
Measurement Conditions:

	Standard Land Pattern
Environment	Mounting on Board (Wind velocity=0m/s)
Board Material	Glass cloth epoxy plastic (Double Layers)
Board Dimensions	40mm × 40mm × 1.6mm
Copper Ratio	Top side: Approx. 50%, Back side: Approx. 50%
Through-hole	φ0.5mm × 44pcs

Measurement Results:

(Ta=25°C)

	Standard Land Pattern	Free Air
Power Dissipation	380mW (Tjmax=125°C) 475mW (Tjmax=150°C)	150mW
Thermal Resistance	$\theta_{ja}=(125-25°C)/0.38W=263°C/W$ $\theta_{jc}=75°C/W$	$\theta_{ja}=(125-25°C)/0.15W=667°C/W$ -



Measurement Board Pattern

IC Mount Area (Unit: mm)

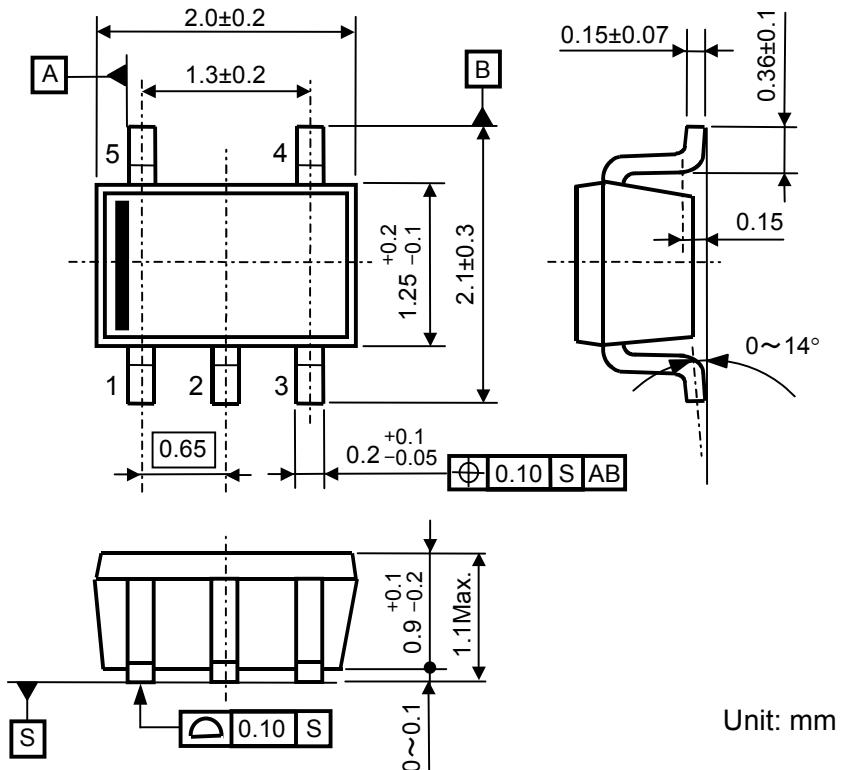
Power Dissipation

The above graph shows the Power Dissipation of the package under the conditions of Tjmax=125°C and Tjmax=150°C.

The operation of the IC within the shaded range in the graph might have an affect on the IC's lifetime. The operation time of the IC must be remained within the time limit described in the table below.

Operating Time	Estimated Years (Operating 4 hours/day)
13,000 hours	9 years

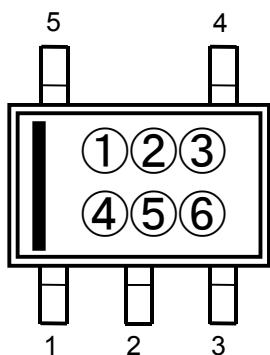
- Package Dimensions (SC-88A)



- Mark Specification (SC-88A)

①②③④: Product Code ... Refer to "Mark Specification Table".

⑤⑥: Lot Number ... Alphanumeric Serial Number



- Power Dissipation (SOT-23-5)

Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:

(Power Dissipation (SOT-23-5) is substitution of SOT-23-6.)

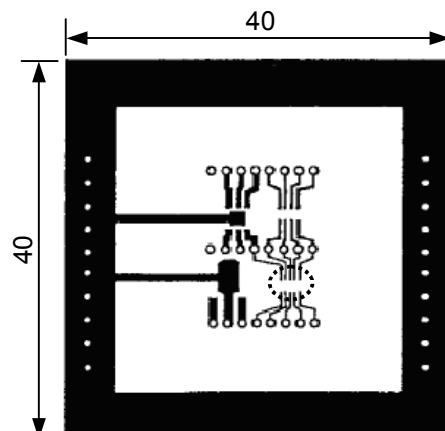
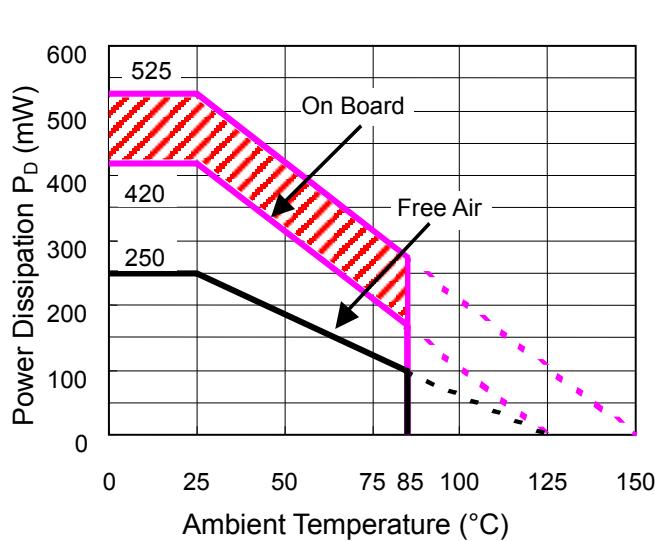
Measurement Conditions:

Standard Land Pattern	
Environment	Mounting on Board (Wind velocity=0m/s)
Board Material	Glass cloth epoxy plastic (Double sided)
Board Dimensions	40mm × 40mm × 1.6mm
Copper Ratio	Top side: Approx. 50%, Back side: Approx. 50%
Through-holes	φ 0.5mm × 44pcs

Measurement Results:

($T_a=25^{\circ}\text{C}$)

	Standard Land Pattern	Free Air
Power Dissipation	420mW ($T_{jmax}=125^{\circ}\text{C}$) 525mW ($T_{jmax}=150^{\circ}\text{C}$)	250mW
Thermal Resistance	$\theta_{ja} = (125-25^{\circ}\text{C})/0.42\text{W} = 238^{\circ}\text{C/W}$	400°C/W



Measurement Board Pattern

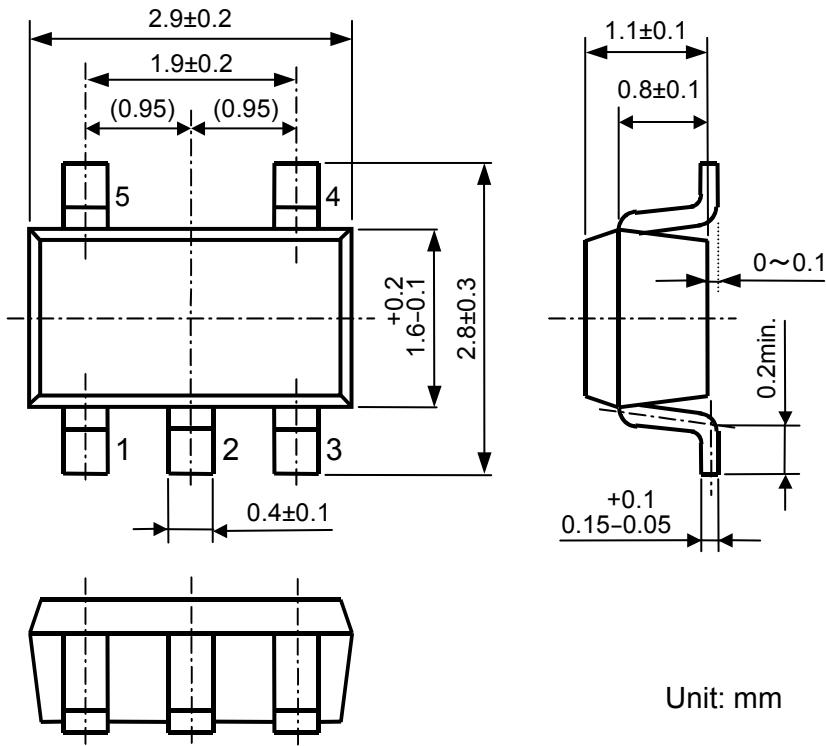
○ IC Mount Area (Unit: mm)

The above graph shows the Power Dissipation of the package under the conditions of $T_{jmax}=125^{\circ}\text{C}$ and $T_{jmax}=150^{\circ}\text{C}$.

The operation of the IC within the shaded range in the graph might have an affect on the IC's lifetime. The operation time of the IC must be remained within the time limit described in the table below.

Operating Time	Estimated Years (Operating 4 hours/day)
13,000 hours	9 years

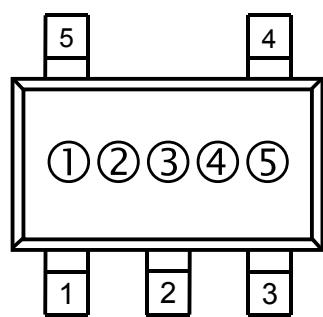
- **Package Dimensions (SOT-23-5)**



- **Mark Specification (SOT-23-5)**

①②③: Product Code ...Refer to “Mark Specification Table”.

④⑤: Lot Number ... Alphanumeric Serial Number



RP171x

NO.EA-245-160324

• RP171N Series Mark Specification Table (SOT-23-5)**RP171Nxx1B**

Product Name	①② ③	Volta ge
RP171N121B	JAA	1.2V
RP171N121B5	JAB	1.25V
RP171N131B	JAC	1.3V
RP171N141B	JAD	1.4V
RP171N151B	JAE	1.5V
RP171N161B	JAF	1.6V
RP171N171B	JAG	1.7V
RP171N181B	JAH	1.8V
RP171N181B5	JAJ	1.85V
RP171N191B	JAK	1.9V
RP171N201B	JAL	2.0V
RP171N211B	JAM	2.1V
RP171N221B	JAN	2.2V
RP171N231B	JAP	2.3V
RP171N241B	JAQ	2.4V
RP171N251B	JAR	2.5V
RP171N261B	JAS	2.6V
RP171N271B	JAT	2.7V
RP171N281B	JAU	2.8V
RP171N281B5	JAV	2.85V
RP171N291B	JAW	2.9V

Product Name	①② ③	Volta ge
RP171N301B	JAX	3.0V
RP171N311B	JAY	3.1V
RP171N321B	JAZ	3.2V
RP171N331B	KAA	3.3V
RP171N341B	KAB	3.4V
RP171N351B	KAC	3.5V
RP171N361B	KAD	3.6V
RP171N371B	KAE	3.7V
RP171N381B	KAF	3.8V
RP171N391B	KAG	3.9V
RP171N401B	KAH	4.0V
RP171N411B	KAJ	4.1V
RP171N421B	KAK	4.2V
RP171N431B	KAL	4.3V
RP171N441B	KAM	4.4V
RP171N451B	KAN	4.5V
RP171N461B	KAP	4.6V
RP171N471B	KAQ	4.7V
RP171N481B	KAR	4.8V
RP171N491B	KAS	4.9V

Product Name	①② ③	Volta ge
RP171N501B	KAT	5.0V
RP171N511B	KAU	5.1V
RP171N521B	KAV	5.2V
RP171N531B	KAW	5.3V
RP171N541B	KAX	5.4V
RP171N551B	KAY	5.5V
RP171N561B	KAZ	5.6V
RP171N571B	LAA	5.7V
RP171N581B	LAB	5.8V
RP171N591B	LAC	5.9V
RP171N601B	LAD	6.0V

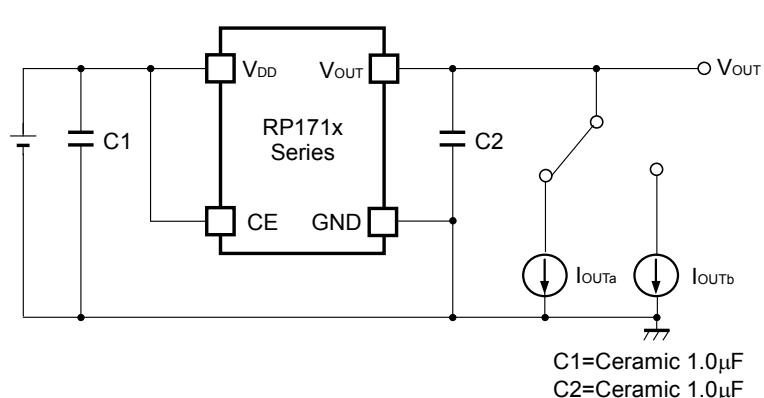
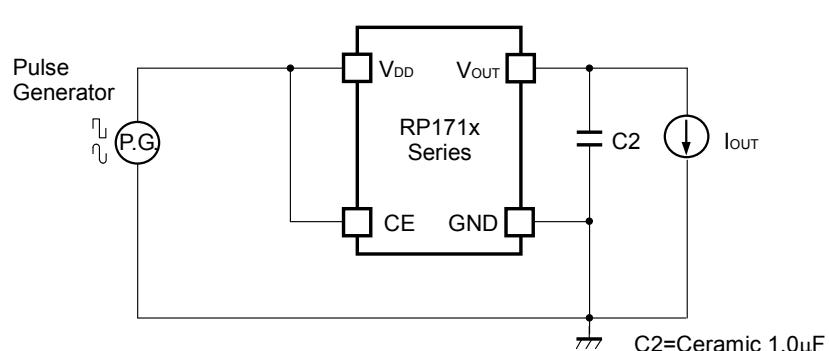
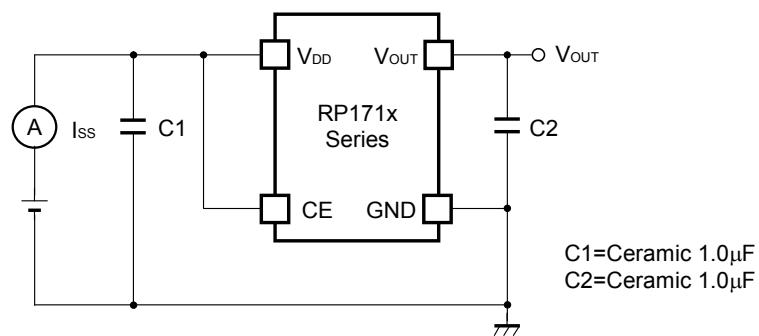
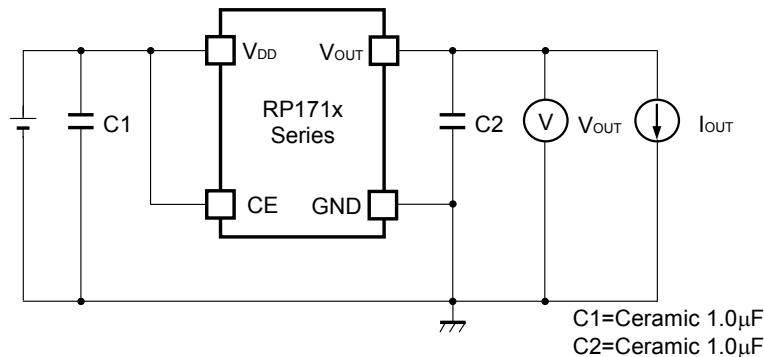
RP171Nxx1D

Product Name	①② ③	Volta ge
RP171N121D	JBA	1.2V
RP171N121D5	JBB	1.25V
RP171N131D	JBC	1.3V
RP171N141D	JBD	1.4V
RP171N151D	JBE	1.5V
RP171N161D	JBF	1.6V
RP171N171D	JBG	1.7V
RP171N181D	JBH	1.8V
RP171N181D5	JBJ	1.85V
RP171N191D	JBK	1.9V
RP171N201D	JBL	2.0V
RP171N211D	JBM	2.1V
RP171N221D	JBN	2.2V
RP171N231D	JBP	2.3V
RP171N241D	JBQ	2.4V
RP171N251D	JBR	2.5V
RP171N261D	JBS	2.6V
RP171N271D	JBT	2.7V
RP171N281D	JBU	2.8V
RP171N281D5	JBV	2.85V
RP171N291D	JBW	2.9V

Product Name	①② ③	Volta ge
RP171N301D	JBX	3.0V
RP171N311D	JBY	3.1V
RP171N321D	JBZ	3.2V
RP171N331D	KBA	3.3V
RP171N341D	KBB	3.4V
RP171N351D	KBC	3.5V
RP171N361D	KBD	3.6V
RP171N371D	KBE	3.7V
RP171N381D	KBF	3.8V
RP171N391D	KBG	3.9V
RP171N401D	KBH	4.0V
RP171N411D	KBJ	4.1V
RP171N421D	KBK	4.2V
RP171N431D	KBL	4.3V
RP171N441D	KBM	4.4V
RP171N451D	KBN	4.5V
RP171N461D	KBP	4.6V
RP171N471D	KBQ	4.7V
RP171N481D	KBR	4.8V
RP171N491D	KBS	4.9V

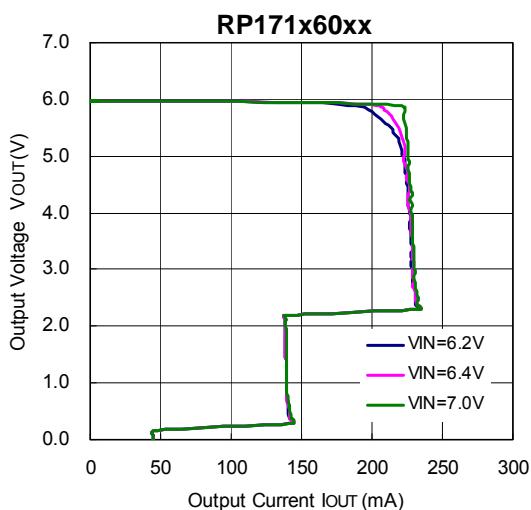
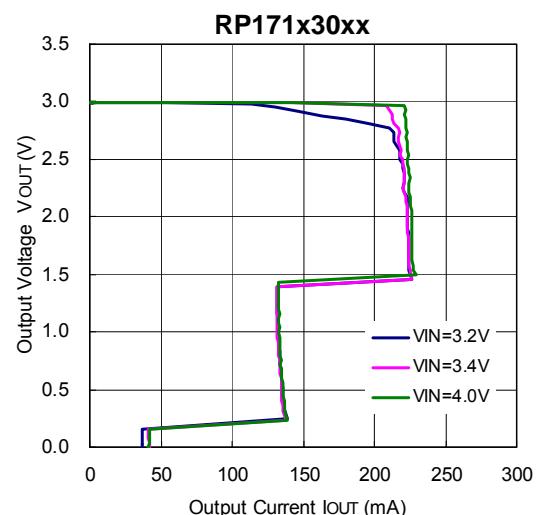
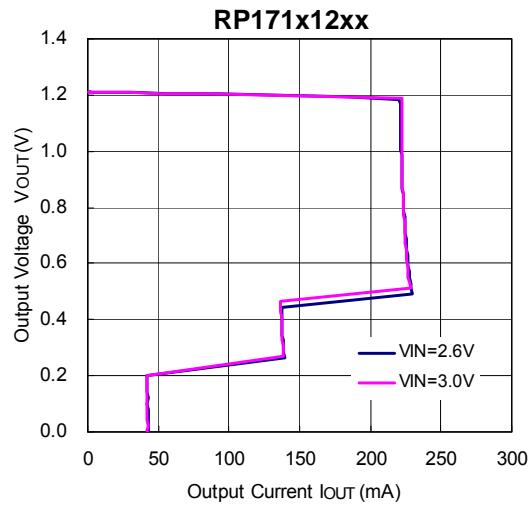
Product Name	①② ③	Volta ge
RP171N501D	KBT	5.0V
RP171N511D	KBU	5.1V
RP171N521D	KBV	5.2V
RP171N531D	KBW	5.3V
RP171N541D	KBX	5.4V
RP171N551D	KBY	5.5V
RP171N561D	KBZ	5.6V
RP171N571D	LBA	5.7V
RP171N581D	LBB	5.8V
RP171N591D	LBC	5.9V
RP171N601D	LBD	6.0V

TEST CIRCUITS

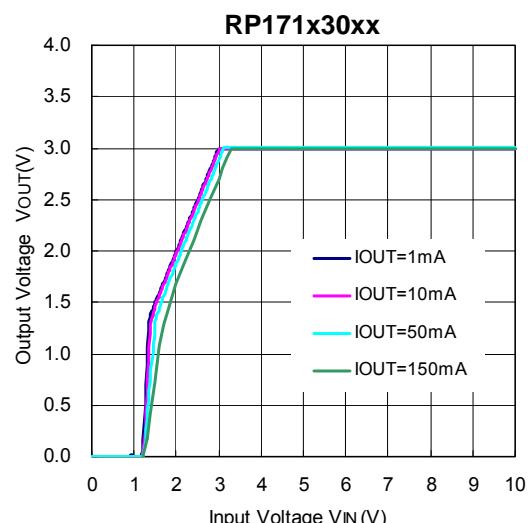
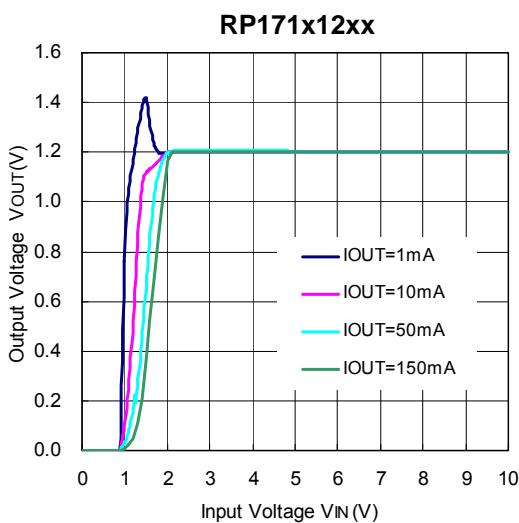


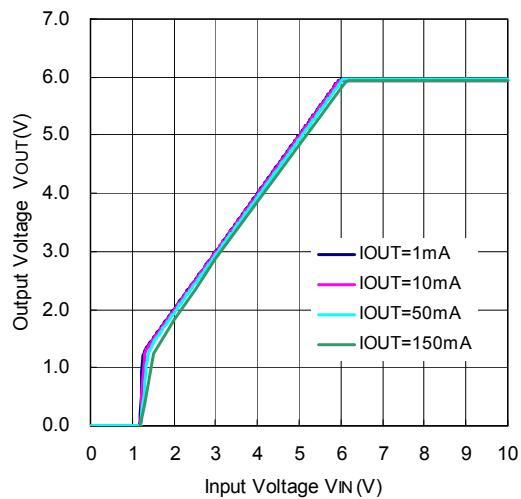
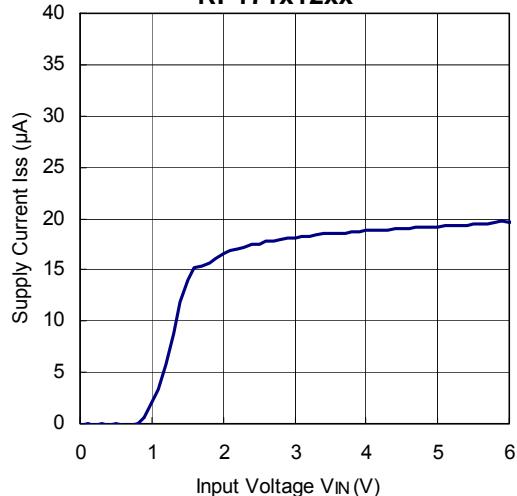
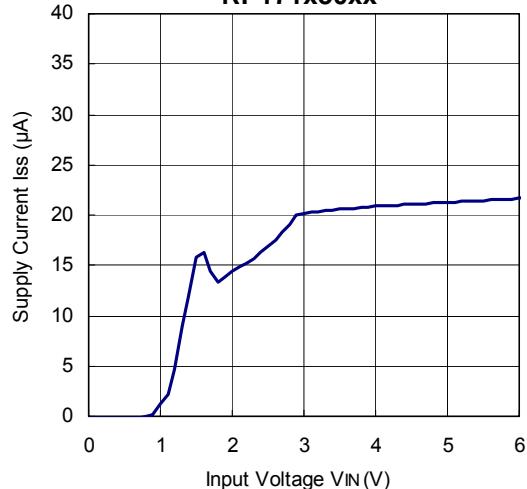
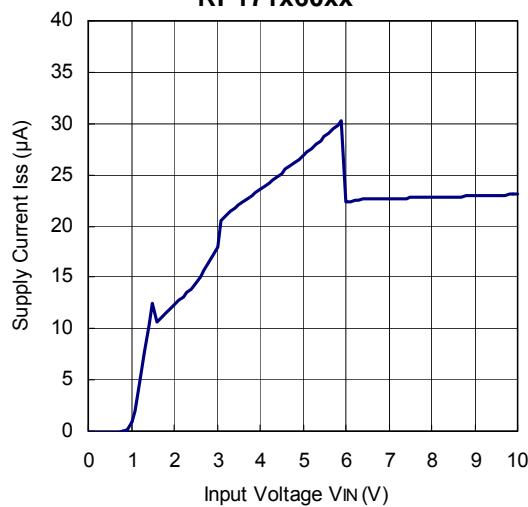
TYPICAL CHARACTERISTICS

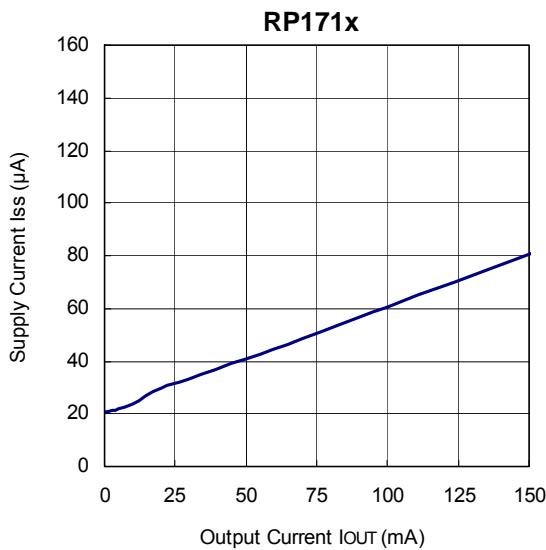
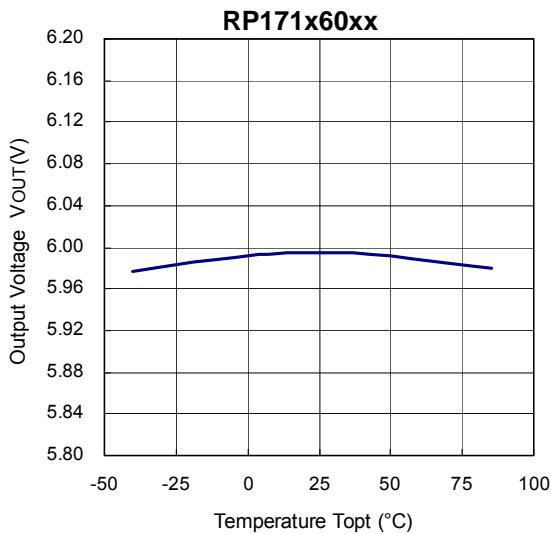
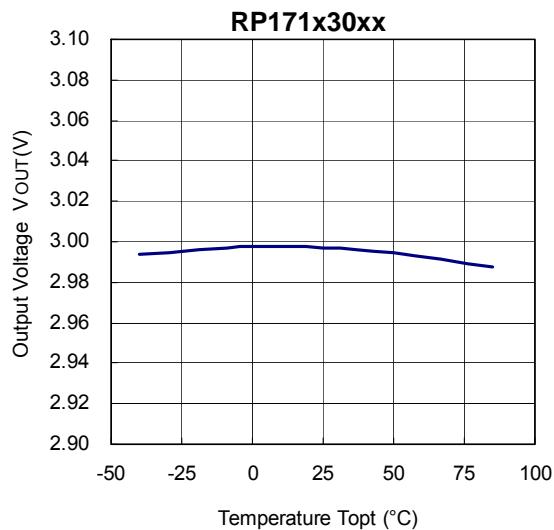
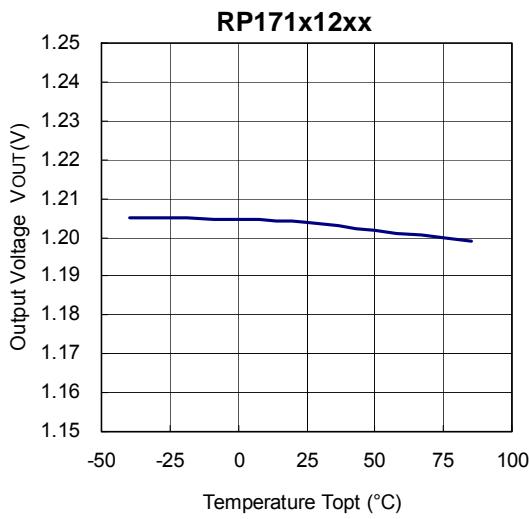
1) Output Voltage vs. Output Current ($T_{opt}=25^{\circ}\text{C}$)



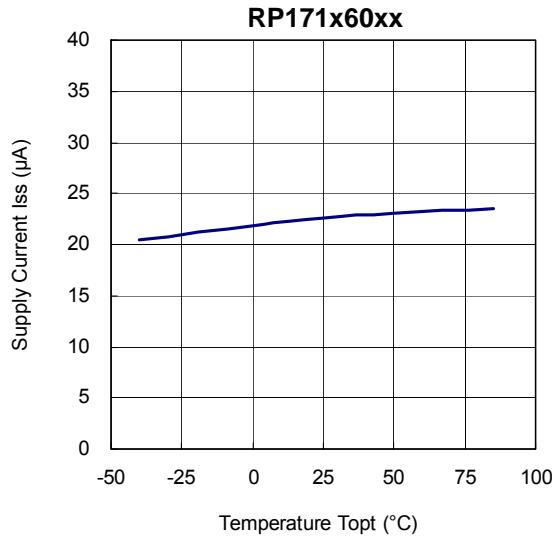
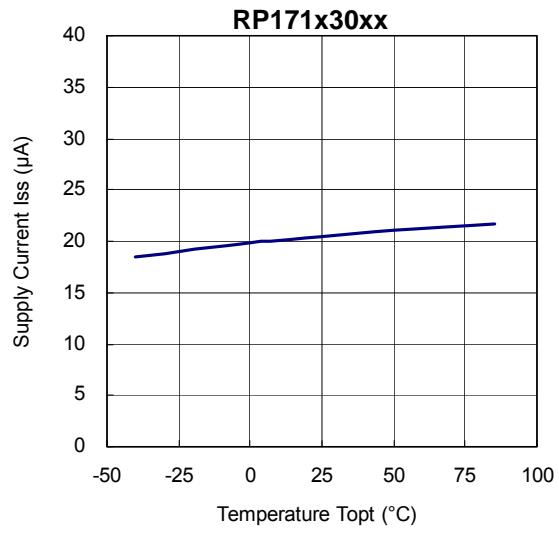
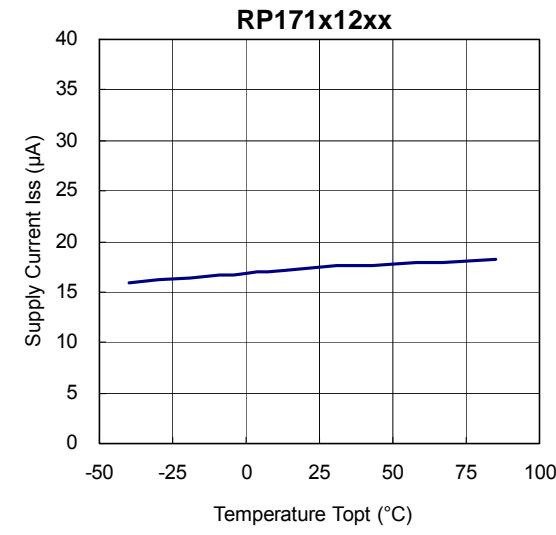
2) Output Voltage vs. Input Voltage ($T_{opt}=25^{\circ}\text{C}$)



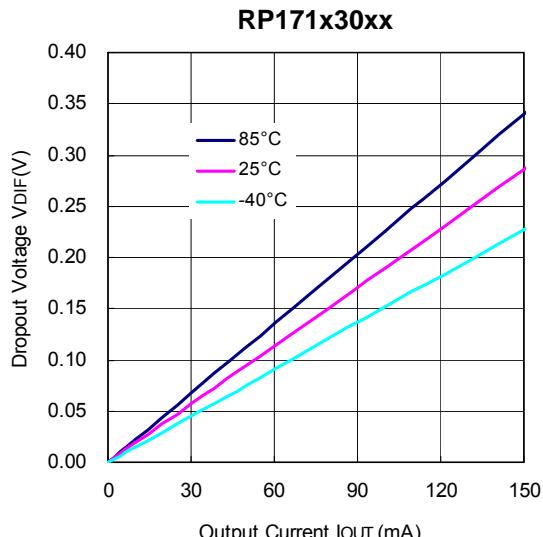
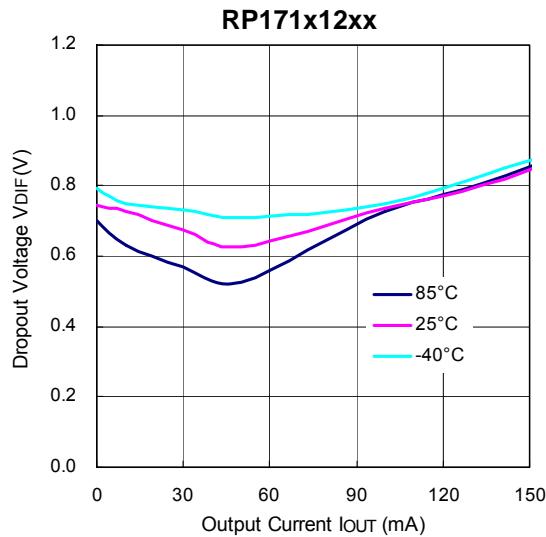
RP171x60xx**3) Supply Current vs. Input Voltage (T_{opt}=25°C)****RP171x12xx****RP171x30xx****RP171x60xx**

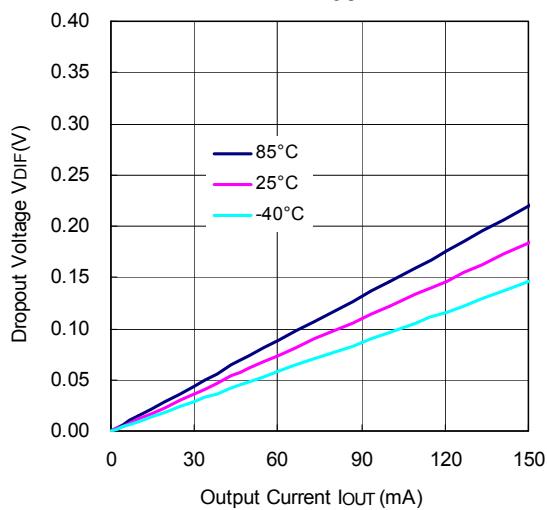
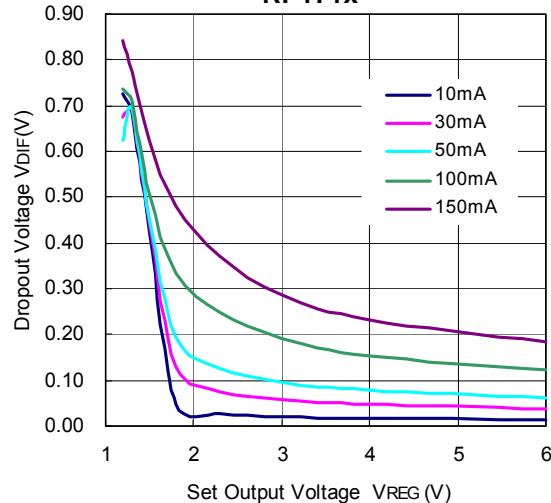
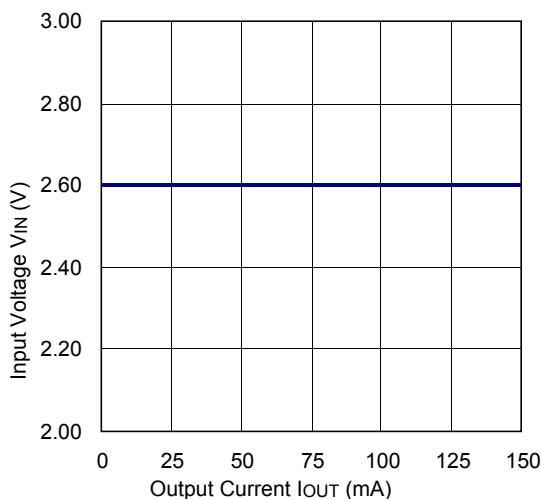
4) Supply Current vs. Output Current ($T_{opt}=25^{\circ}\text{C}$)**5) Output Voltage vs. Temperature**

6) Supply Current vs. Temperature

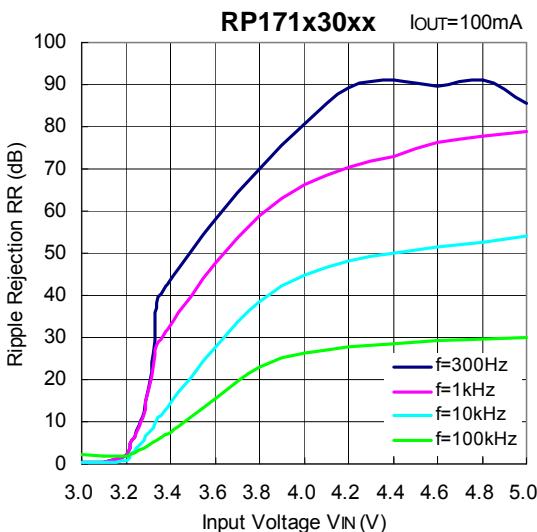
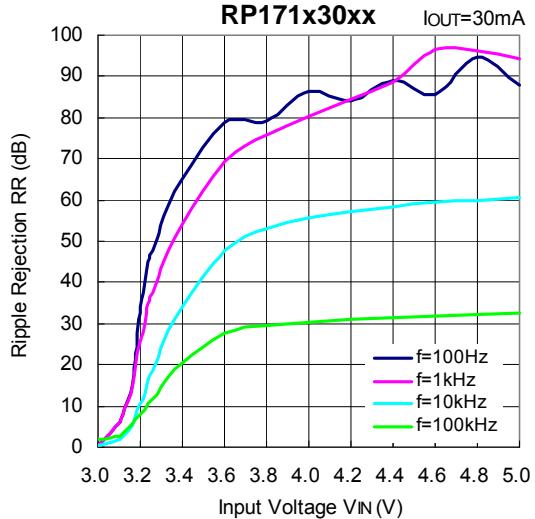
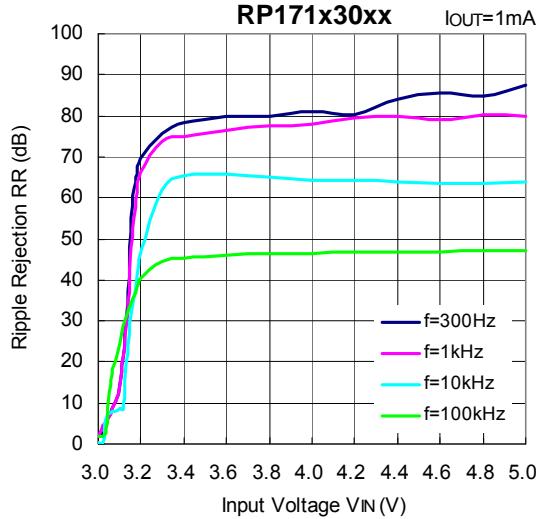


7) Dropout Voltage vs. Output Current

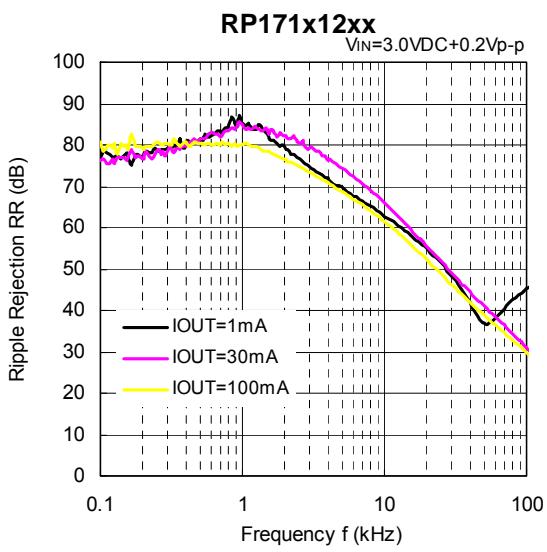
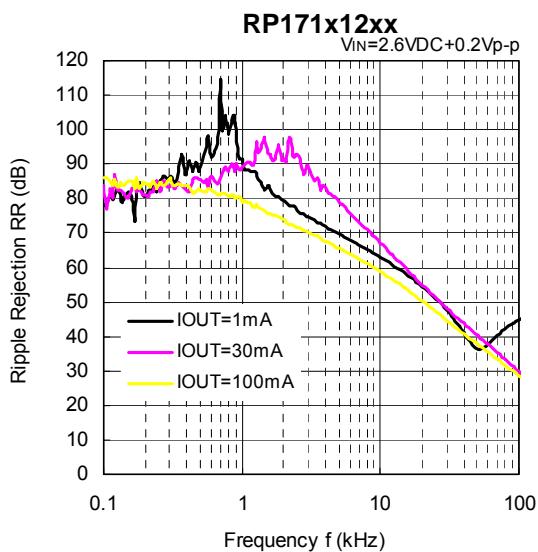


RP171x60xx**8) Dropout Voltage vs. Set Output Voltage ($T_{opt}=25^{\circ}\text{C}$)****RP171x****9) Minimum Operating Voltage****RP171x12xx**

10) Ripple Rejection vs. Input Bias Voltage (C1=none, C2=Ceramic 1.0 μ F, Ripple=0.2Vp-p, T_{opt}=25°C)

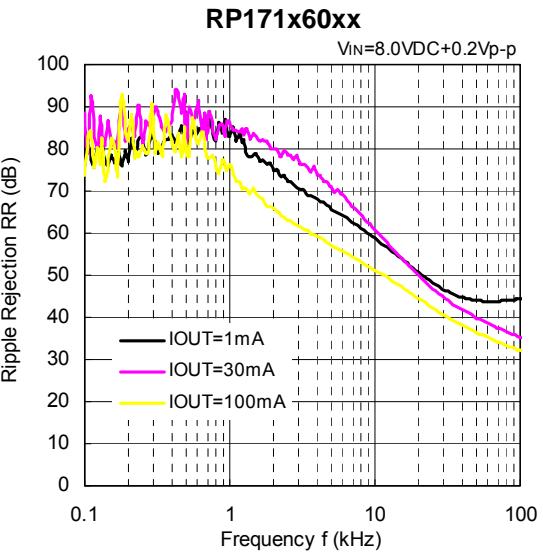
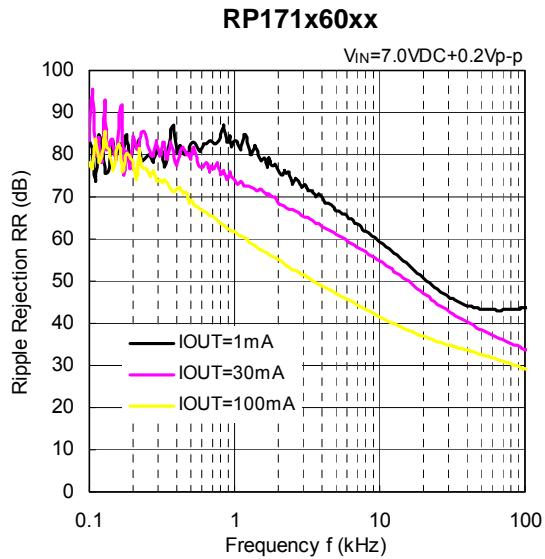
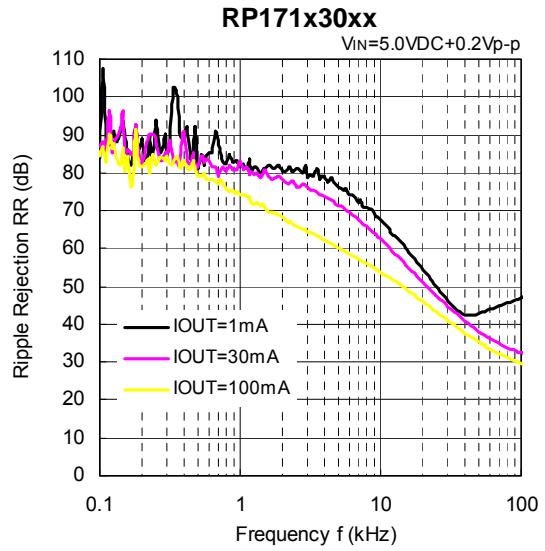
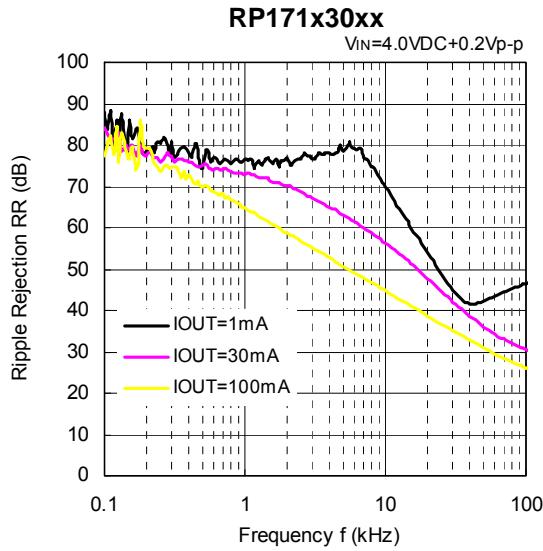


11) Ripple Rejection vs. Frequency (C1=none, C2=Ceramic 1.0 μ F, T_{opt}=25°C)

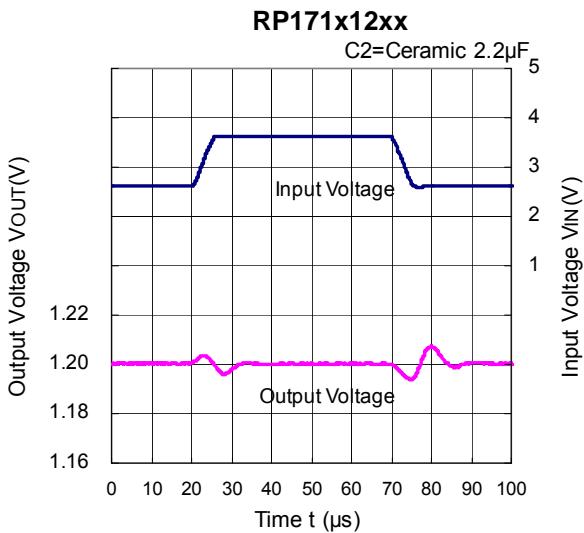
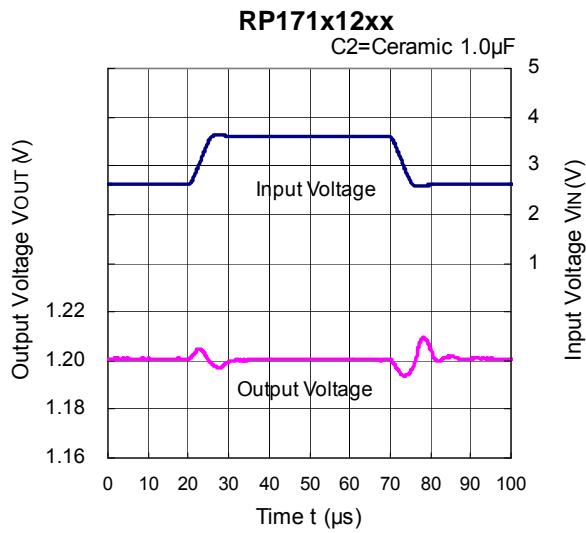


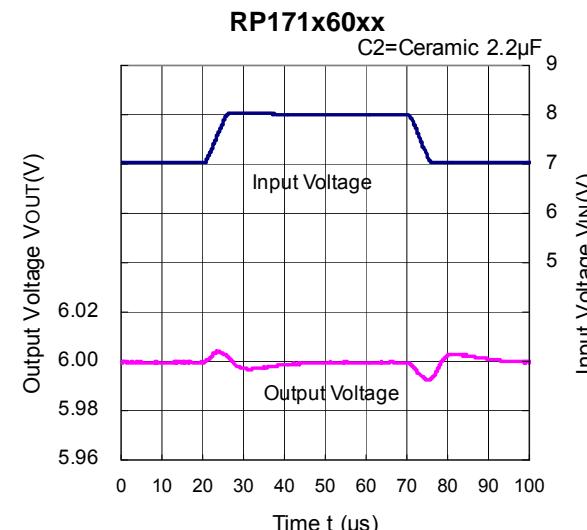
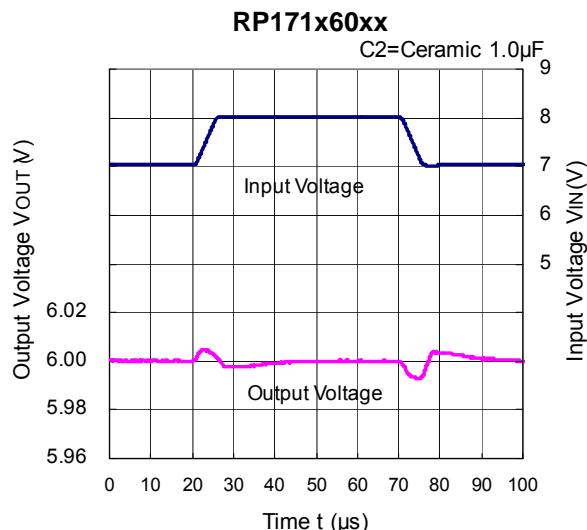
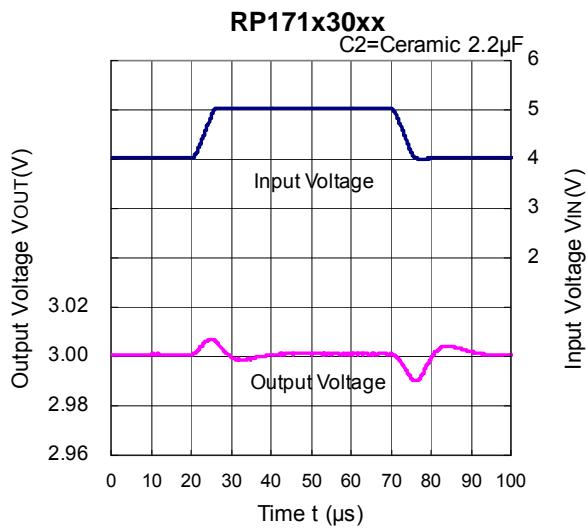
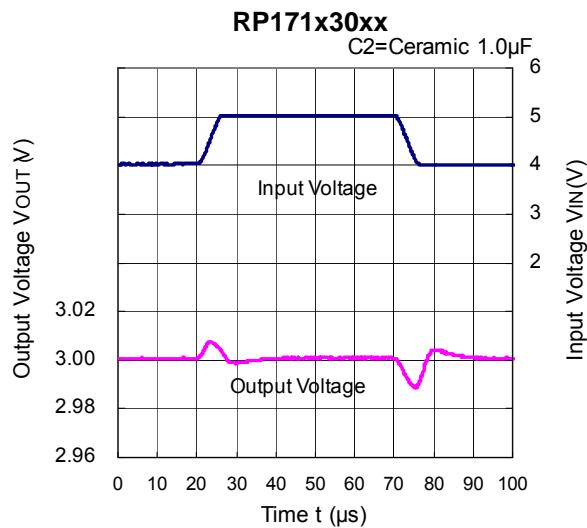
RP171x

NO.EA-245-160324

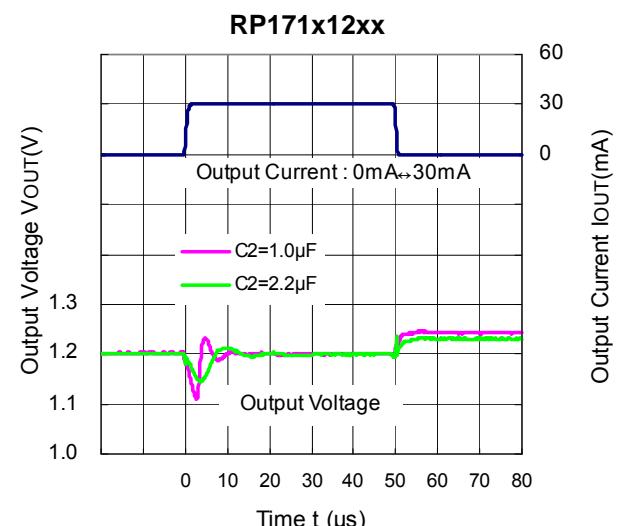
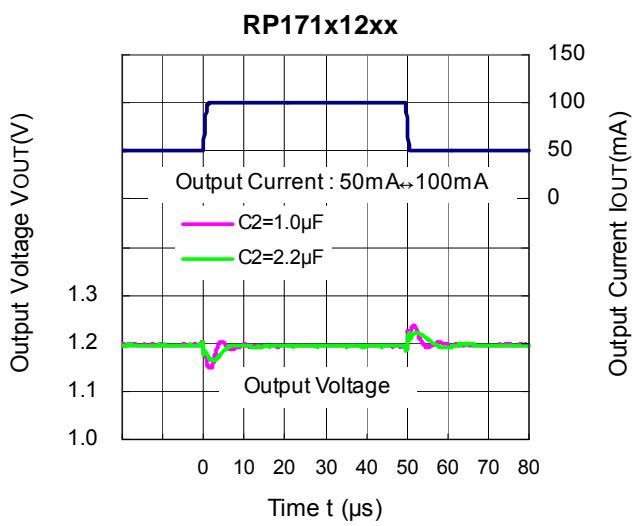


12) Input Transient Response ($C_1=\text{none}$, $I_{OUT}=30\text{mA}$, $\text{tr}=\text{tf}=5\mu\text{s}$, $T_{opt}=25^\circ\text{C}$)





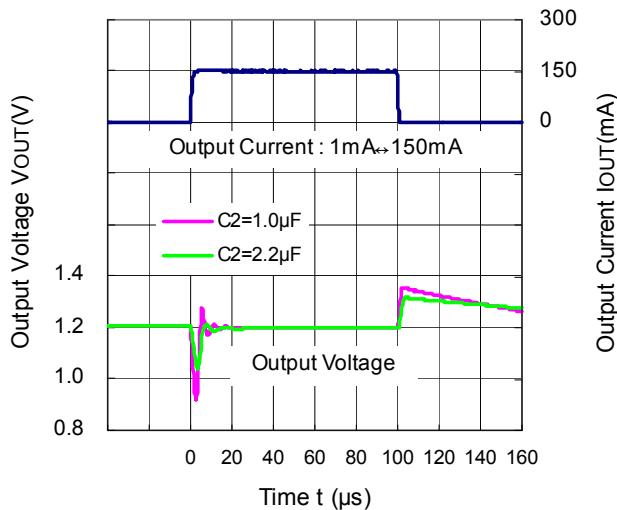
13) Load Transient Response (C1=Ceramic 1.0 μ F, tr=tf=500ns, Topt=25°C)



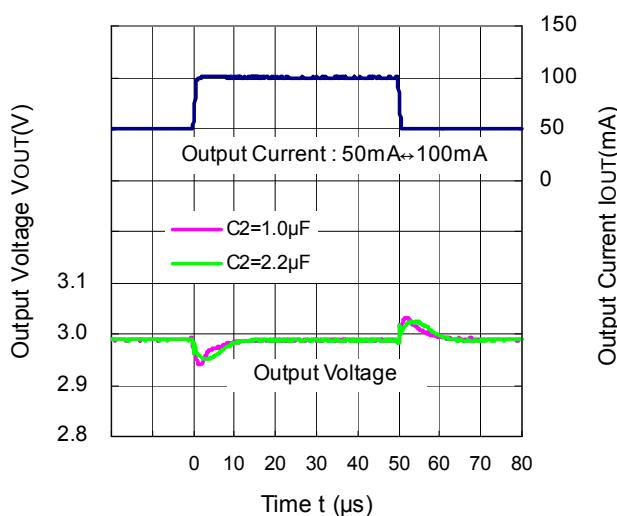
RP171x

NO.EA-245-160324

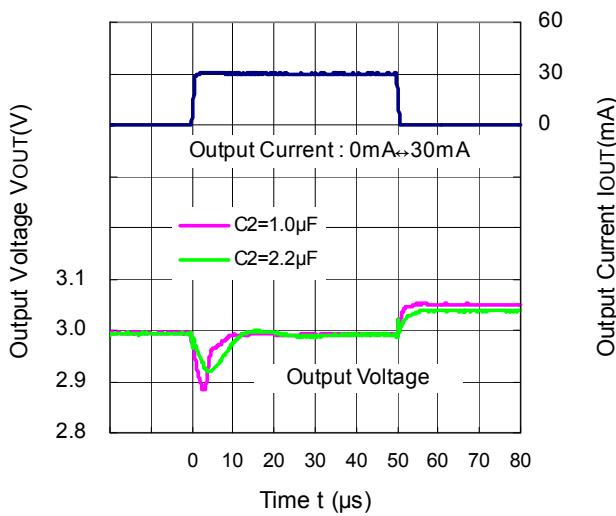
RP171x12xx



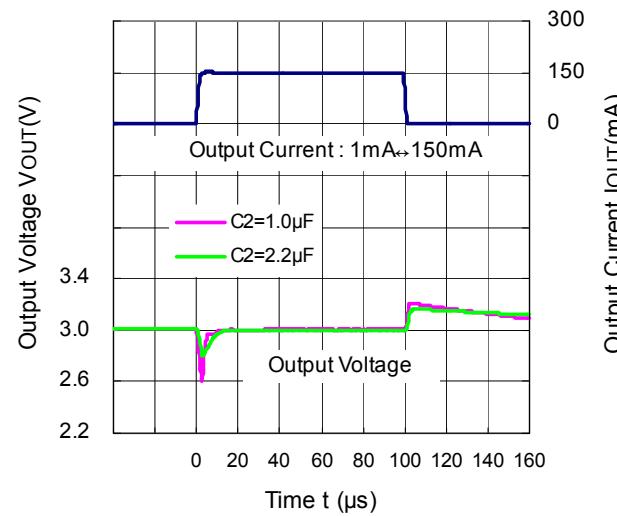
RP171x30xx



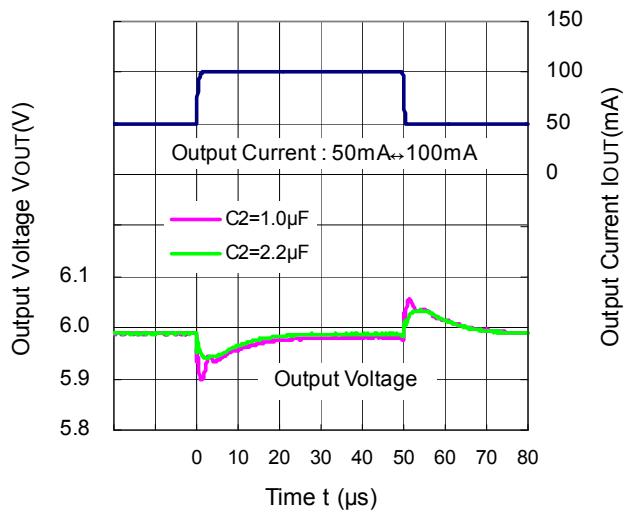
RP171x30xx



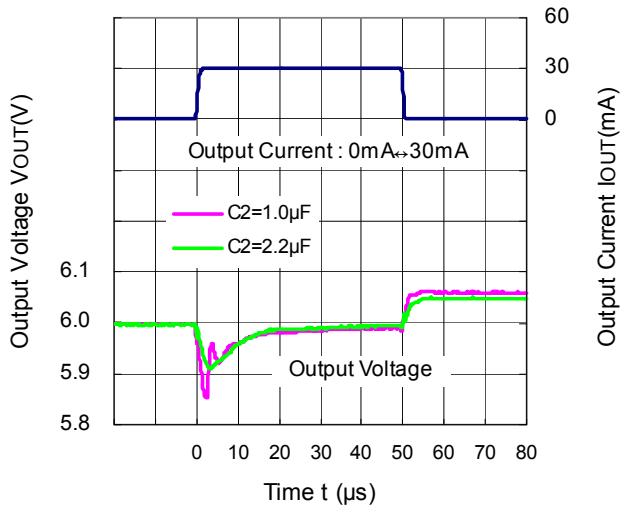
RP171x30xx



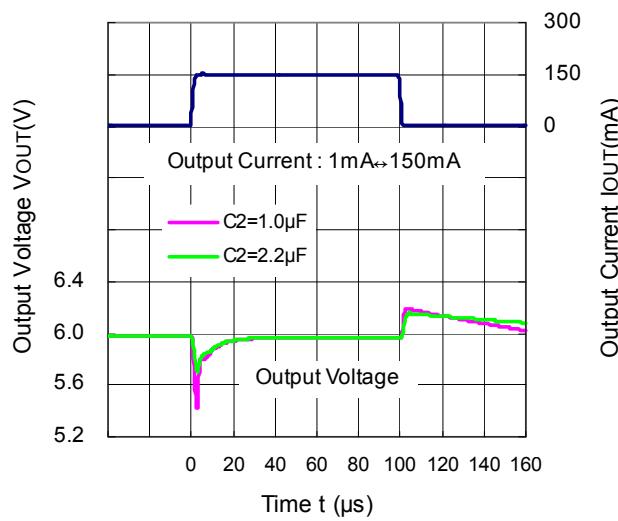
RP171x60xx



RP171x60xx

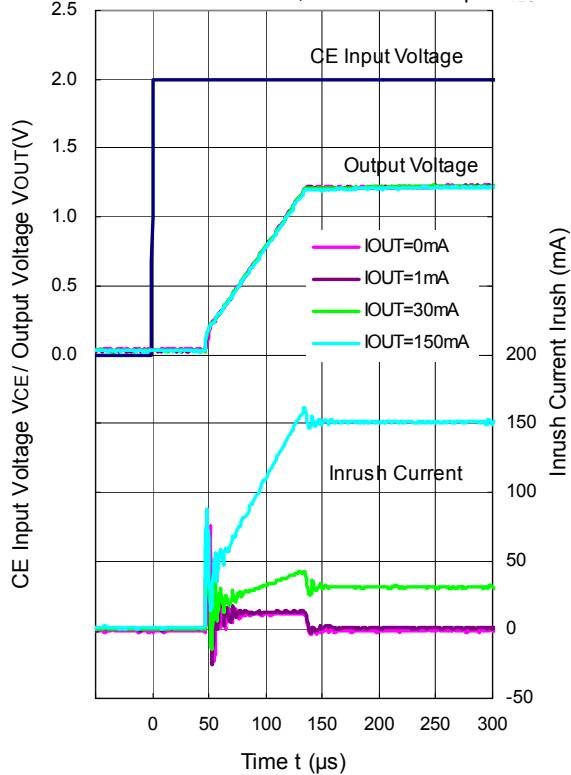


RP171x60xx

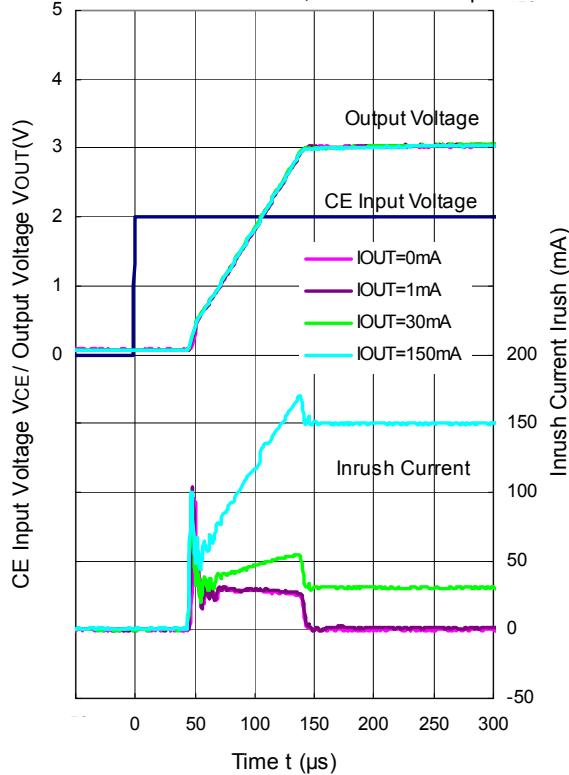


14) Turn On Speed with CE pin (C1=Ceramic 1.0 μ F, T_{opt}=25°C)

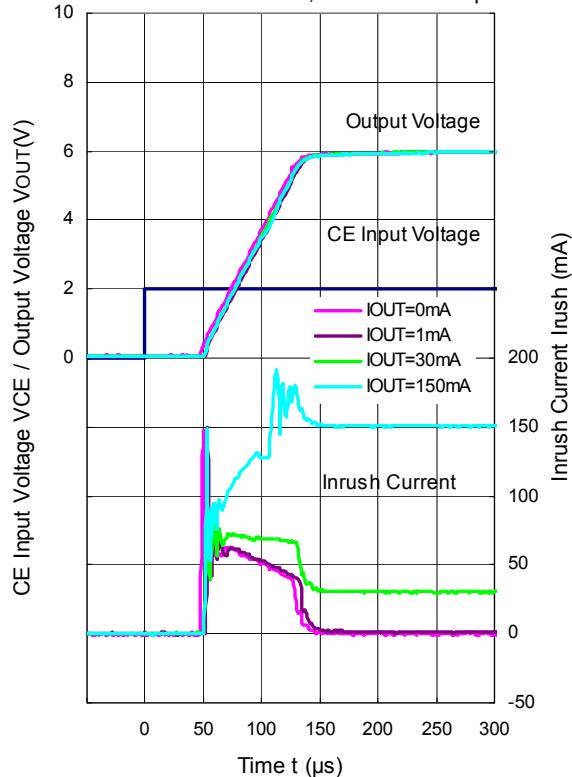
RP171x12xx

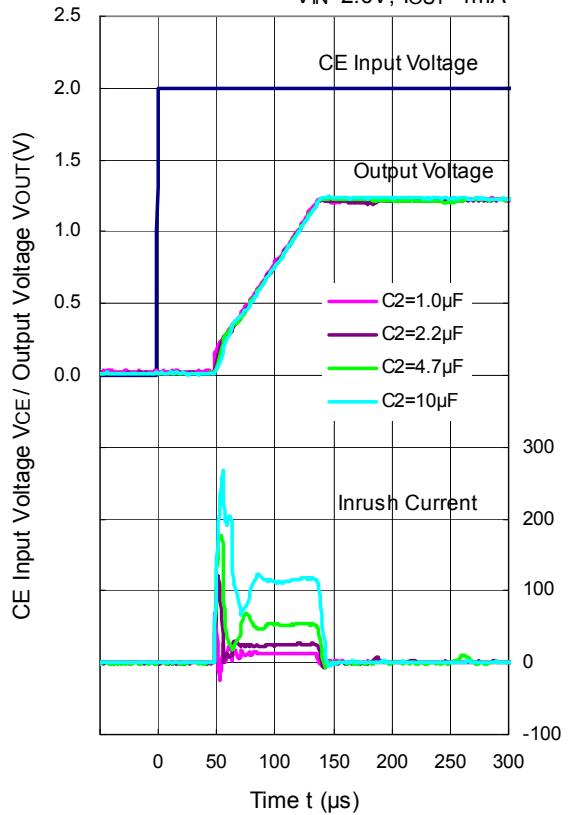
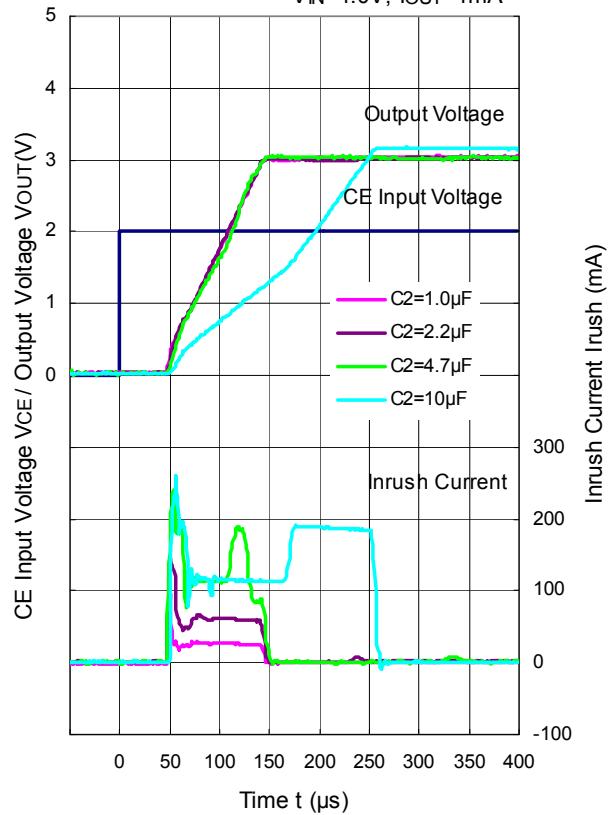
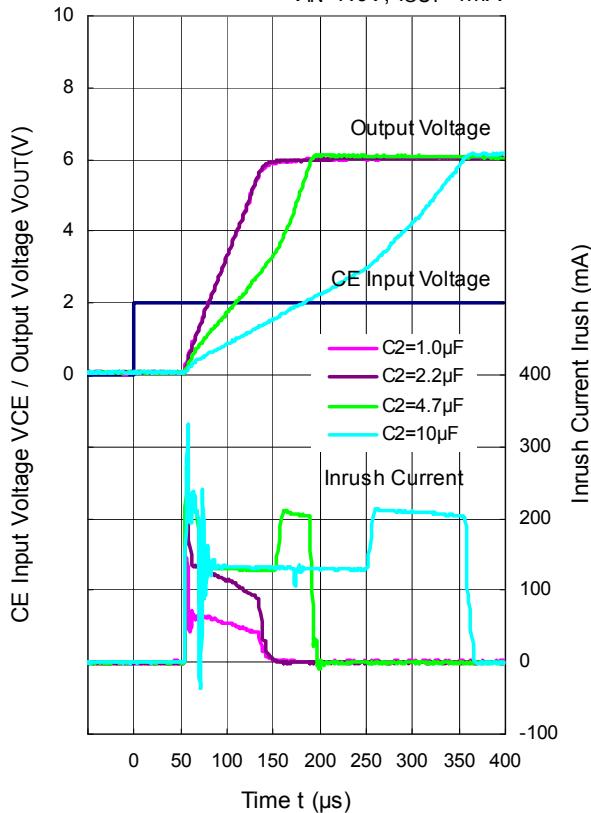
V_{IN}=2.6V, C₂=Ceramic1.0 μ F

RP171x30xx

V_{IN}=4.0V, C₂=Ceramic1.0 μ F

RP171x60xx

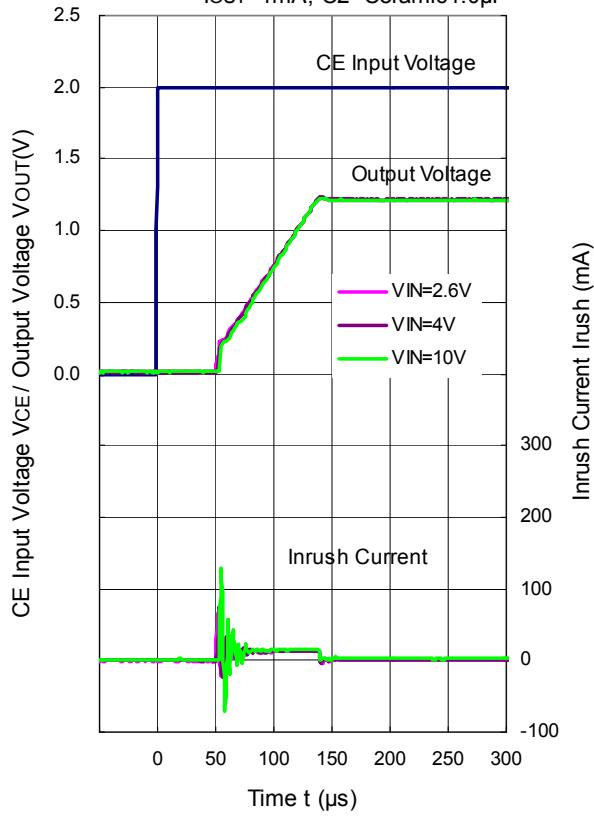
V_{IN}=7.0V, C₂=Ceramic1.0 μ F

RP171x12xxV_{IN}=2.6V, I_{OUT}=1mA**RP171x30xx**V_{IN}=4.0V, I_{OUT}=1mA**RP171x60xx**V_{IN}=7.0V, I_{OUT}=1mA

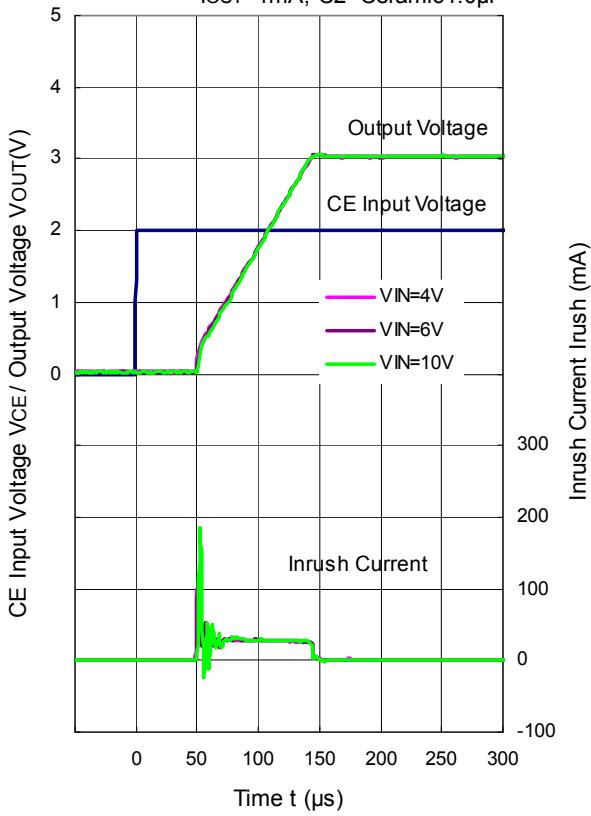
RP171x

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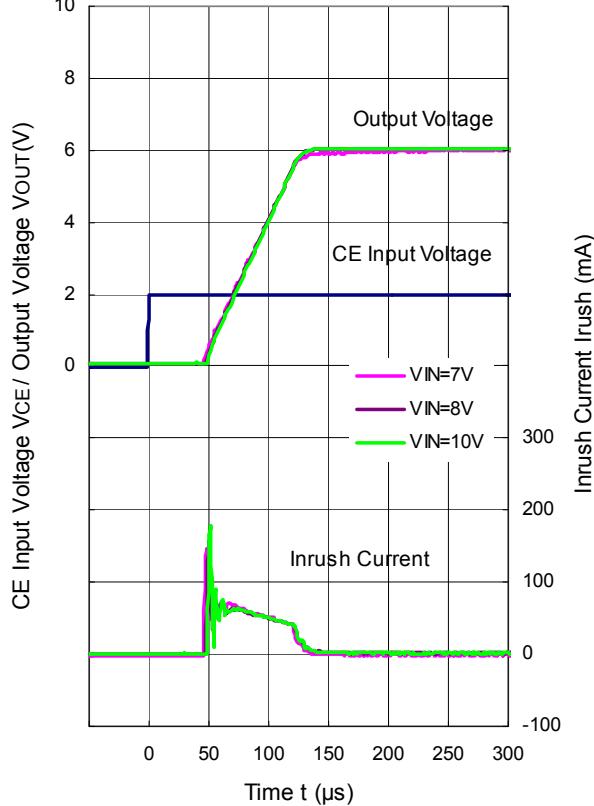
RP171x12xx
I_{OUT}=1mA, C₂=Ceramic1.0μF



RP171x30xx
I_{OUT}=1mA, C₂=Ceramic1.0μF

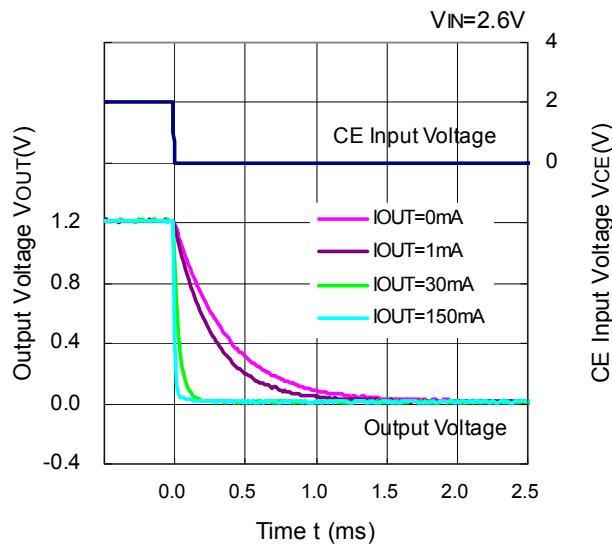


RP171x60xx
I_{OUT}=1mA, C₂=Ceramic1.0μF

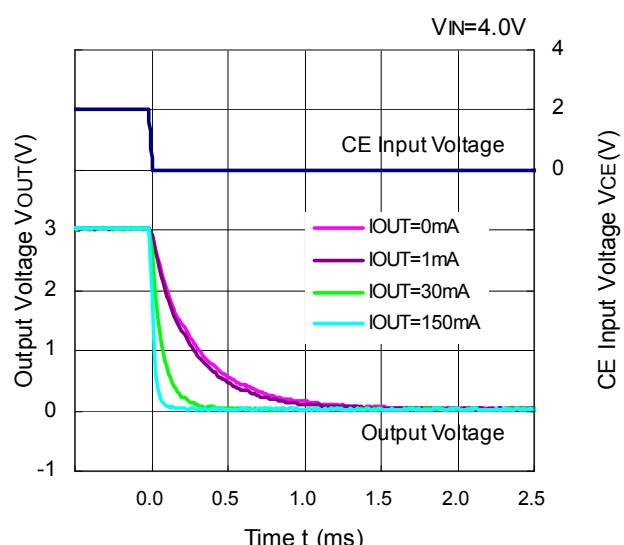


15) Turn Off Speed with CE pin (D Version) (C1=Ceramic 1.0 μ F, T_{opt}=25°C)

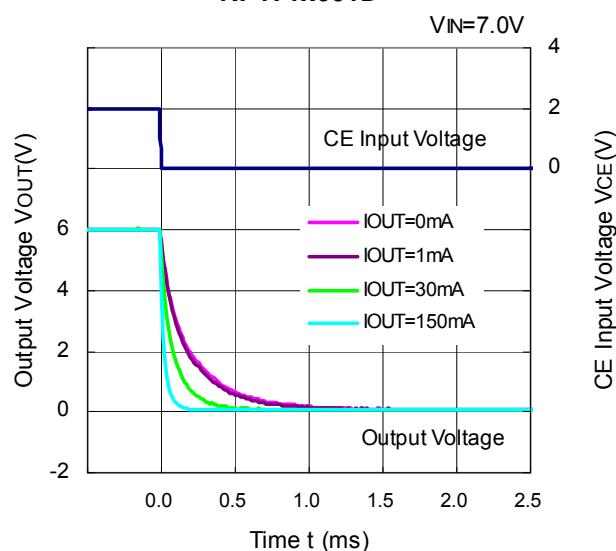
RP171x121D



RP171x301D



RP171x601D



ESR vs. Output Current

When using these ICs, consider the following points:

The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below.

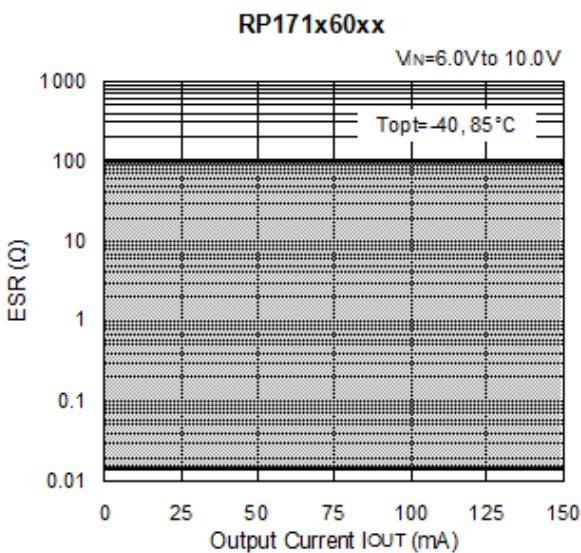
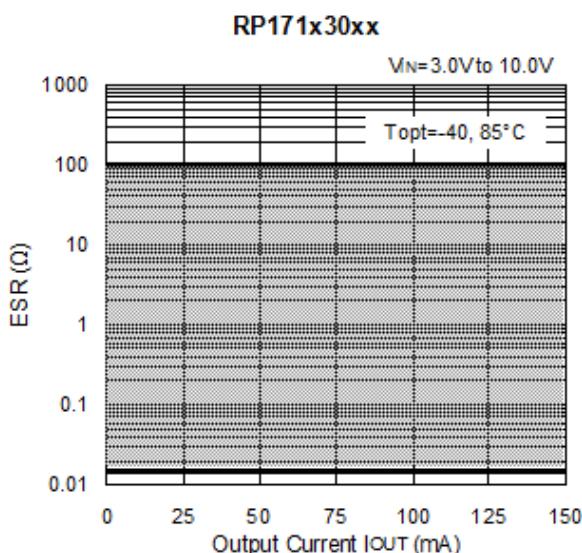
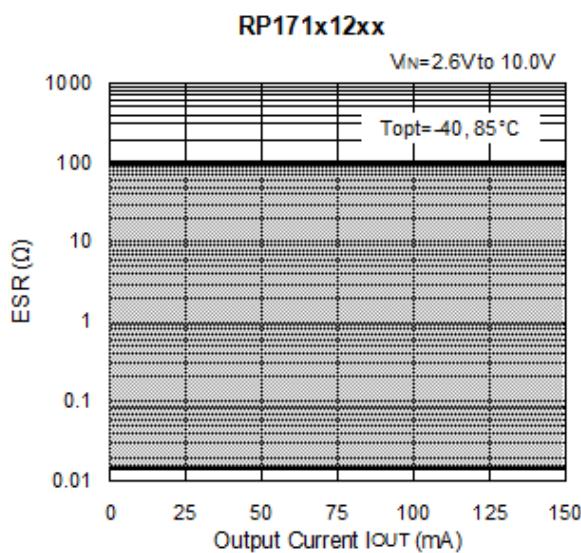
The conditions when the white noise level is under $40\mu V$ (Avg.) are marked as the hatched area in the graph.

Measurement conditions

Frequency Band : 10Hz to 2MHz

Temperature : $-40^{\circ}C$ to $85^{\circ}C$

C1, C2 : Ceramic 1.0 μF (Murata GRM155B31A105KE)





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